

REMARKS

The Official Action dated August 29, 2002 has been carefully considered.

Accordingly, the changes presented herewith, taken with the following remarks, are believed sufficient to place the present application in condition for allowance. Reconsideration is respectfully requested.

In the Official Action, the Examiner requested a new Title of the patent application that is clearly indicative of the invention to which the claims are directed. By the present amendment, the title has been amended to clearly be indicative of the invention to which the claims are directed. The new title of the application is "Process of Cleaning Dishware Using a Dishwashing Wipe Having a Cleaning Substrate and a Scrubbing Substrate." A Version With Markings Showing Changes Made is attached. It is therefore submitted that the newly amended title is clearly indicative of the invention. Reconsideration is respectfully requested.

By the present amendment, claims 1-19 have been canceled and claims 20-39 have been added. Support for claims 20-39 may be found in original claims 1-19. The specification has been amended on page 35 by deleting the first paragraph. It is believed that these changes do not involve any introduction of new matter, whereby entry is believed to be in order and is respectfully requested.

In the Official Action, the Examiner acknowledged the foreign priority claim based on the application filed in the European Patent Office on November 27, 2000. The Examiner requested a certified copy of the foreign application. We are presently in the process of obtaining a certified copy of the foreign application and will forward the copy when we have obtained it.

In the Official Action, claims 1-19 were rejected under 35 U.S.C. §103(a) as being unpatentable over Deleo et al., U.S. Patent No. 6,340,663. The Examiner asserted that Deleo et al. disclose a cleaning wipe for hard surfaces impregnated with at least one layer of non-

woven material and comprising a surfactant. The Examiner noted that Deleo et al. does not teach or disclose a dishwashing wipe. The Examiner asserted that it would have been obvious to one skilled in the art to use the wipe on surfaces such as dishes.

However, Applicants submit that the processes defined by the present claims 20-39 are nonobvious over Deleo et al. Accordingly, this rejection is traversed and reconsideration is respectfully requested.

The present invention, as defined by claim 20, relates to a process of cleaning dishware using a disposable dishwashing wipe comprising contacting the dishwashing wipe with water and subsequently contacting the dishware with the dishwashing wipe. The dishwashing wipe comprises a non-woven or paper cleaning substrate, and a comparatively more abrasive scrubbing substrate comprising a polymeric mesh or scrim selected from the group consisting of polyamide fibers, polyethylene fibers, polypropylene fibers and mixtures thereof.

As defined by claim 39, the present invention relates to a process of cleaning dishware using a disposable dishwashing wipe comprising the steps of contacting the dishwashing wipe with water and subsequently contacting the dishware with the dishwashing wipe. The dishwashing wipe comprises at least two water impermeable membranes, wherein the water impermeable membranes comprise polyethylene membranes; at least two non-woven or paper cleaning substrates, wherein the cleaning substrates comprises batting; and at least two comparatively more abrasive scrubbing substrates, wherein the scrubbing substrates comprise a polymeric scrim selected from the group consisting of polyamide fibers, polyethylene fibers, polypropylene fibers and mixtures thereof.

Deleo et al. disclose a cleaning wipe for hard surfaces. The cleaning wipe comprises at least one layer of a non-woven material and a liquid cleaner comprising a surfactant, a hydrophilic polymer and water. Deleo et al. disclose the cleaning wipe comprises a single

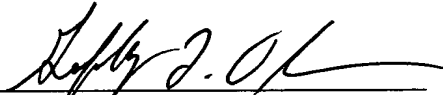
substrate, preferably being a non-woven sheet. However, Applicants find no teaching by Deleo et al. of a process for cleaning dishware employing a wipe comprising at least one non-woven or paper cleaning substrate and a comparatively more abrasive scrubbing substrate comprising a polymeric mesh or scrim.

To establish prima facie obviousness of the claimed invention, all the claim limitations must be taught or suggested by the prior art, *In re Royka*, 490 F.2d 981, 180 U.S.P.Q. 580 (CCPA 1974). Furthermore, references relied upon to support a rejection under 35 U.S.C. §103 must provide an enabling disclosure, i.e., they must place the claimed invention in the possession of the public, *In re Payne*, 203 U.S.P.Q. 245 (CCPA 1979). Deleo et al. do not disclose a process for cleaning dishware using a comparatively more abrasive scrubbing substrate comprising a polymeric mesh or scrim selected from the group consisting of: polyamide fibers, polyethylene fibers, polypropylene fibers and mixtures thereof, particularly in combination with a cleaning substrate as presently claimed. In addition, Deleo et al. do not disclose a dishwashing process using a wipe comprising at least two water impermeable membranes, wherein the water impermeable membranes comprise polyethylene membranes; at least two non-woven or paper cleaning substrates, wherein the cleaning substrate comprises batting; and at least two more comparatively scrubbing substrates, wherein the scrubbing substrates comprise a polymeric scrim selected from the group consisting of: polyamide fibers, polyethylene fibers, polypropylene fibers and mixtures thereof. In view of the failure of Deleo et al. to provide any teaching, suggestion or disclosure of a process employing a more comparatively abrasive scrubbing substrate, comprising a polymeric mesh or scrim selected from the group consisting of: polyamide fibers, polyethylene fibers, polypropylene fibers and mixtures thereof, particularly in combination with the additional wipe components of claims 20 and 39, Deleo et al. do not enable one skilled in the art to make and use the presently claimed process of cleaning

dishware using a disposable dishwashing wipe. Thus, Deleo et al. do not render the presently claimed process obvious under 35 U.S.C. §103.

It is believed that the above represents a complete response to the objections and rejections under 35 U.S.C. §103 and places the present application in condition for allowance. Reconsideration and an early allowance are requested.

Respectfully submitted,

By 

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Version With Markings Showing Changes Made

In the Title:

Please amend the title to read as follows:

--Process of Cleaning Dishware Using a Dishwashing Wipe Having a Non-Woven
Cleaning Substrate and a Scrubbing Substrate--.